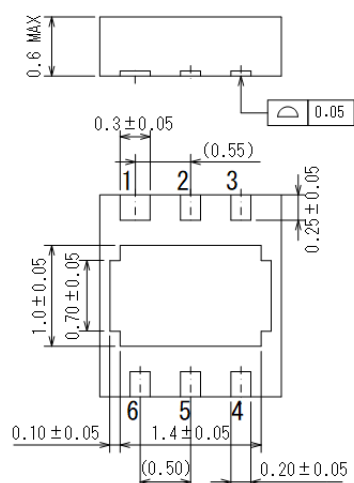
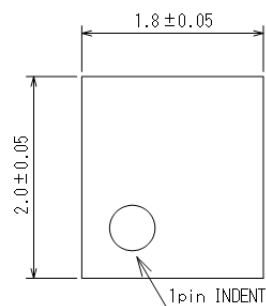


Packaging Information / Reference Pattern Layout Dimensions

● USP-6C

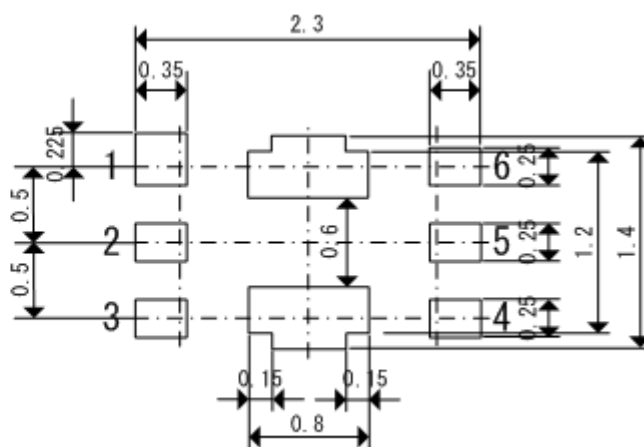
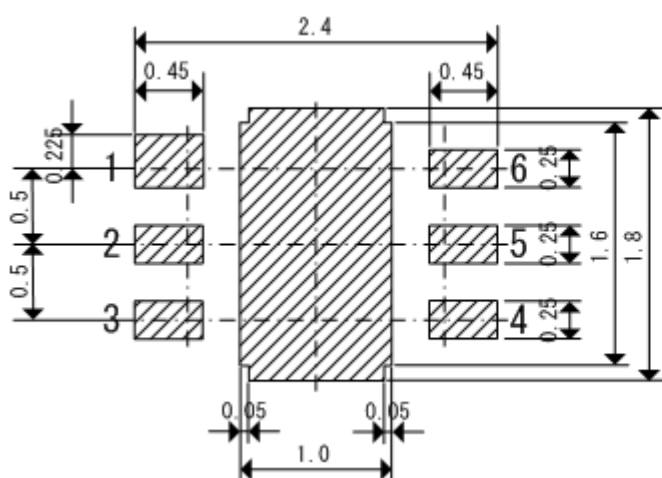
■ Packaging Information

Unit: mm



■ Reference Pattern Layout Dimension

Note : reference metal mask design



• Solder thickness: 120 μm (Ref.)